

Precision Monolithics Inc.

## 1.0 SCOPE

This specification covers the detail requirements for a low bias current JFET operational amplifier.

It is highly recommended that this data sheet be used as a baseline for new military or aerospace spec control drawings.

## 1.2 Part Number. The complete part numbers per Table I of this specification follow:

<u>Device</u>	<u>Part Number</u>	<u>Package</u>
A	OP-41AJ/883	J
B	OP-41BJ/883	J

## 1.2.3 Case Outline.

<u>Letter</u>	<u>Case Outline (Lead finish per MIL-M-38510)</u>
J	8-lead metal can (TO-99)

## 1.3 Absolute Maximum Ratings. ( $T_A = 25^\circ\text{C}$ , unless otherwise noted)

Supply Voltage.....	$\pm 18\text{V}$
Power Dissipation.....	500mW
Differential Input Voltage (Note 1).....	$\pm 18\text{V}$
Input Voltage (Note 1).....	$\pm 18\text{V}$
Output Short-Circuit Duration.....	Indefinite
Storage Temperature Range.....	-65°C to +150°C
Lead Temperature (Soldering, 60 sec).....	+300°C
Maximum Junction Temperature ( $T_J$ ).....	$\pm 150^\circ\text{C}$

### NOTES:

1. For supply voltages less than  $\pm 18\text{V}$ , the maximum input voltage is equal to the supply voltages.

## 1.5 Thermal Characteristics:

Thermal Resistance, TO-99 (J) package:

Junction-to-Case ( $\Theta_{JC}$ ) = 45°C/W MAX

Junction-to-Ambient ( $\Theta_{JA}$ ) = 150°C/W MAX

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TABLE 1

$V_S = \pm 15V$ ;  $V_{CM} = 0V$ ;  $R_S = 50\Omega$ ;  $T_A = 25^\circ C$  unless otherwise specified.

Characteristics	Symbol	Special Conditions	OP-41/883				Units
			Min	Max	Min	Max	
<b>Input Offset Voltage</b>	$V_{OS}$	$-55^\circ C \leq T_A \leq +125^\circ C$	—	500	—	1000	$\mu V$
<b>Input Offset Current</b>	$I_{OS}$	(Note 1) $-55^\circ C \leq T_A \leq +125^\circ C$	—	1	—	2	pA
<b>Input Bias Current</b>	$I_B$	(Note 1) Either Input $-55^\circ C \leq T_A \leq +125^\circ C$	—	$\pm 5.0$	—	$\pm 10.0$	pA
<b>Input Voltage Range (Note 2)</b>	IVR	$-55^\circ C \leq T_A \leq +125^\circ C$	$\pm 11.0$	—	$\pm 11.0$	—	V
<b>Common-Mode Rejection</b>	CMR	$V_{CM} = \pm 11V$	100	—	90	—	dB
		$V_{CM} = \pm 11V$ $-55^\circ C \leq T_A \leq +125^\circ C$	95	—	85	—	dB
<b>Power Supply Rejection Ratio</b>	PSRR	$V_S = \pm 10V$ to $\pm 18V$ $V_S = \pm 10V$ to $\pm 18V$ $-55^\circ C \leq T_A \leq +125^\circ C$	—	25	—	80	$\mu V/V$
<b>Large-Signal Voltage Gain</b>	$A_{VO}$	$V_O = \pm 10V$ , $R_L = 2k\Omega$	1000	—	500	—	V/mV
		$V_O = \pm 10V$ , $R_L = 2k\Omega$ $-55^\circ C \leq T_A \leq +125^\circ C$	1000	—	500	—	V/mV
<b>Supply Current</b>	$I_{SY}$	No Load	—	1.0	—	1.2	mA
		No Load $-55^\circ C \leq T_A \leq +125^\circ C$	—	1.2	—	1.2	mA
<b>Output Voltage Swing</b>	$V_O$	$R_L = 2k\Omega$	$\pm 12.3$	—	$\pm 12.0$	—	V
		$R_L = 2k\Omega$ $-55^\circ C \leq T_A \leq +125^\circ C$	$\pm 12.0$	—	$\pm 11.5$	—	V

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TABLE 1 (Continued) $V_S = \pm 15V$ ;  $V_{CM} = 0V$ ;  $R_S = 50\Omega$ ;  $T_A = 25^\circ C$  unless otherwise specified.

Characteristics	Symbol	Special Conditions	OP-41/883		LIMITS A		LIMITS B		Units
			Min	Max	Min	Max	Min	Max	
<b>Output Short-Circuit Current</b>	$I_{SC}$	Short circuit to ground	$\pm 12$	$\pm 36$	$\pm 12$	$\pm 36$	mA		mA
		Short circuit to ground $-55^\circ C \leq T_A \leq +125^\circ C$	$\pm 6$	$\pm 36$	$\pm 6$	$\pm 36$	mA		
<b>Slew Rate</b>	SR	$A_V = +1$ $-55^\circ C \leq T_A \leq +125^\circ C$	1	—	1	—	$V/\mu s$		
<b>Temperature Coefficient of Input Offset Voltage</b>	$TCV_{OS}$	$-55^\circ C \leq T_A \leq +125^\circ C$	—	5	—	10	$\mu V/^\circ C$		

## NOTES:

1.  $I_B$  and  $I_{OS}$  are tested at  $+25^\circ C$  ambient with devices warmed up.
2. IVR is defined as the  $V_{CM}$  range used for the CMR test.

**[PMI]****TABLE 2****OP-41/883****Electrical Test Requirements  
For Class B Devices****5**

OPERATIONAL AMPLIFIERS

MIL-STD-883 Test Requirements	Subgroups (see Table 3)
Interim Electrical Parameters (pre Burn-In)	1
Final Electrical Test Parameters	1*, 2, 3, 4, 5, 6, 8, 9, 10, 11
Group A Test Requirements	1, 2, 3, 4, 5, 6, 8, 9, 10, 11

\* PDA applies to Subgroup 1 only.  
No other Subgroups are included in PDA.

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**TABLE 3**

**Group A Inspection**

$V_S = \pm 15V$ ;  $V_{CM} = 0V$ ;  $R_S = 50\Omega$ ;  $T_A = T_J$  unless otherwise specified.

<b>Subgroup</b>	<b>Symbol</b>	<b>Special Conditions</b>	<b>OP-41/883</b>				<b>Units</b>
			<b>LIMITS A</b>	<b>Min</b>	<b>Max</b>	<b>LIMITS B</b>	
<b>Subgroup 1</b>	$V_{OS}$		—	500	—	1000	$\mu V$
$T_A = +25^\circ C$	$A_{VO}$	$V_O = \pm 10V$ , $R_L = 2k\Omega$	1000	—	500	—	$V/mV$
	$V_O$	$R_L = 2k\Omega$	$\pm 12.3$	—	$\pm 12.0$	—	$V$
	CMR	$V_{CM} = \pm 11V$	100	—	90	—	$dB$
	PSRR	$V_S = \pm 10V, \pm 18V$	—	25	—	80	$\mu V/V$
	$I_{SC}$	Short circuit to ground	$\pm 12$	$\pm 36$	$\pm 12$	$\pm 36$	$mA$
	$I_{SY}$	No Load	—	1.0	—	1.2	$mA$
<b>Subgroup 2</b>	$V_{OS}$		—	1000	—	2000	$\mu V$
$T_A = +125^\circ C$	$I_{OS}$		—	1	—	2	$nA$
	$I_B$	Either Input	—	$\pm 7.5$	—	$\pm 15.0$	$nA$
	CMR	$V_{CM} = \pm 11V$	95	—	85	—	$dB$
	PSRR	$V_S = \pm 10V, \pm 18V$	—	40	—	100	$\mu V/V$
	$I_{SC}$	Short circuit to ground	$\pm 6$	$\pm 36$	$\pm 6$	$\pm 36$	$mA$
	$I_{SY}$	No Load	—	1.2	—	1.2	$mA$
<b>Subgroup 3</b>	All Tests, Limits and Conditions are the same as for Subgroup 2.						
$T_A = -55^\circ C$							

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**TABLE 3**

**Group A Inspection (Continued)**

$V_S = \pm 15V$ ;  $V_{CM} = 0V$ ;  $R_S = 50\Omega$ ;  $T_A = T_J$  unless otherwise specified.

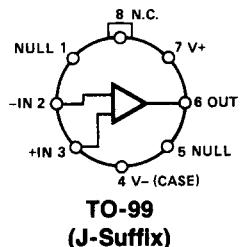
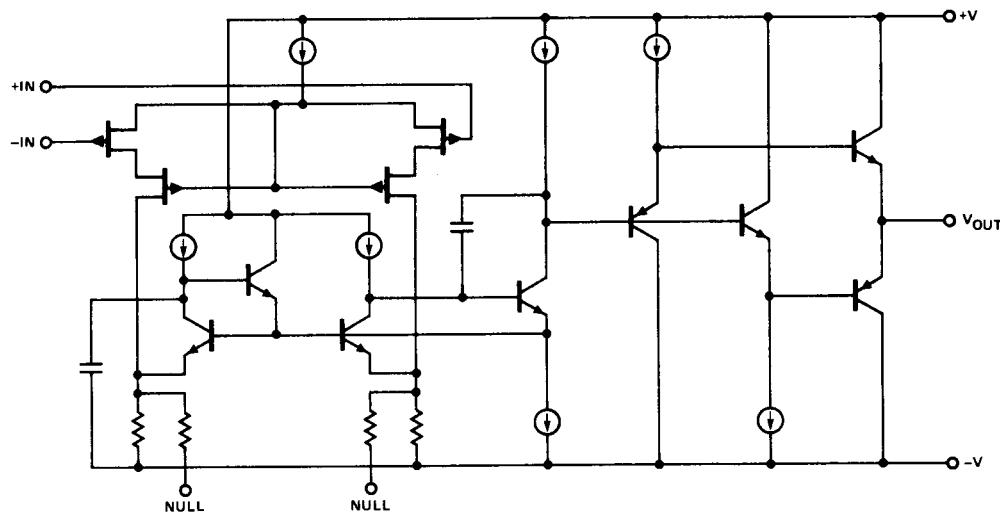
Subgroup	Symbol	Special Conditions	OP-41/883				Units
			Min	Max	Min	Max	
<b>Subgroup 4</b>	$I_{OS}$	(Note 1)	1	-	2	-	pA
$T_A = +25^\circ C$	$I_B$	(Note 1) Either Input	5	-	10	-	pA
<b>Subgroup 5</b>	$V_O$	$R_L = 2k\Omega$	$\pm 12.0$	-	$\pm 11.5$	-	V
$T_A = +125^\circ C$	$A_{VO}$	$V_O = \pm 10V$ , $R_L = 2k\Omega$	1000	-	500	-	V/mV
<b>Subgroup 6</b> $T_A = -55^\circ C$		All Tests, Limits and Conditions are the same as for Subgroup 5.					
<b>Subgroup 8</b> $T_A = -55^\circ C, +125^\circ C$	$TCV_{OS}$		-	5	-	10	$\mu V/^\circ C$
<b>Subgroup 9</b> $T_A = +25^\circ C$	SR		1	-	1	-	$V/\mu s$
<b>Subgroup 10</b> $T_A = +125^\circ C$		All Tests, Limits and Conditions are the same as for Subgroup 9.					
<b>Subgroup 11</b> $T_A = -55^\circ C$		All Tests, Limits and Conditions are the same as for Subgroup 9.					

**NOTES:**

1.  $I_B$  and  $I_{OS}$  in Subgroup 4 are tested at  $+25^\circ C$  ambient with devices warmed up.

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### 3.2.1 Simplified Schematic and Pin Connections.



**3.2.4 Microcircuit Group Assignment.** This microcircuit is covered by microcircuit group 61.

### 4.2 Life Test/Burn-In Circuit.

